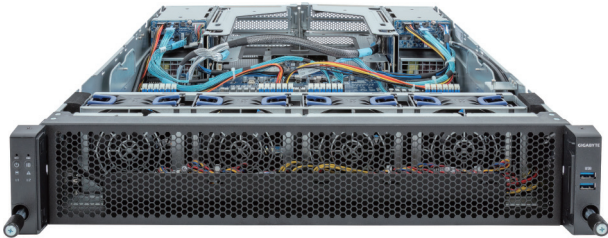


E283-Z90-AAV1

Edge Server - 2U DP 4-Bay NVMe/SATA



Key Features

- Dual AMD EPYC™ 9005/9004 Series Processors
- 12-Channel DDR5 RDIMM, 24 x DIMMs
- Dual ROM Architecture
- 2 x 1Gb/s LAN ports via Intel® I350-AM2
- 4 x 2.5" Gen4 NVMe/SATA/SAS hot-swap bays on the rear side
- 2 x M.2 slots with PCIe Gen3 x4 and x2 interface
- 6 x FHHL PCIe Gen5 x16 and x8 slots
- 2 x OCP NIC 3.0 PCIe Gen5 x16 slots
- Dual 1600W 80 PLUS Titanium redundant power supply

Application

Networking, Edge, Hybrid/Private Cloud Server...

Specification

Dimensions 2U (W438 x H87.5 x D625 mm)

Motherboard MZ93-FS0

CPU AMD EPYC™ 9005 Series Processors
AMD EPYC™ 9004 Series Processors
Dual processors, cTDP up to 400W

Sock 2 x LGA 6096 (Socket SP5)

Chipset System on Chip

Memory 12-Channel DDR5 RDIMM
24 x DIMM slots
[EPYC 9005] Up to 6000 MT/s
[EPYC 9004] Up to 4800 MT/s

LAN 2 x 1Gb/s LAN (1 x Intel® I350-AM2) - Supports NCSI function
1 x 10/100/1000 Mbps Management LAN

Video Integrated in ASPEED® AST2600
- 1 x Mini-DP

Storage Rear hot-swap:
4 x 2.5" Gen4 NVMe/SATA/SAS
*SAS card is required to support SAS drives
Internal M.2:
1 x M.2 (2280/22110), PCIe Gen3 x4
1 x M.2 (2280/22110), PCIe Gen3 x2

RAID Require RAID add-in cards

Expansion Slots 4 x FHHL PCIe x16 (Gen5 x16) slots
2 x FHHL PCIe x16 (Gen5 x8) slots
2 x OCP NIC 3.0 PCIe Gen5 x16 slots - Supports NCSI function

I/O Ports Front: 2 x USB 3.2 Gen1
Rear: 2 x USB 3.2 Gen1, 1 x Mini-DP, 2 x RJ45, 1 x MLAN

Backplane Board Speed and bandwidth:
PCIe Gen4 x4 or SATA 6Gb/s or SAS 12Gb/s

Security Modules 1 x TPM header with SPI interface
- Optional TPM2.0 kit: CTM010

Power Supply Dual 1600W 80 PLUS Titanium redundant power supply
AC Input: 100-240V

System Management ASPEED® AST2600 Baseboard Management Controller
GIGABYTE Management Console web interface

OS Support Windows Server, Red Hat Enterprise Linux server, Ubuntu,
SUSE Linux Enterprise server, VMware ESXi, Citrix Hypervisor

System Fans 4 x 80x80x38mm (18,300rpm)

Operating Properties Operating temperature: 10°C to 35°C
Operating humidity: 8%-80% (non-condensing)
Non-operating temperature: -40°C to 60°C
Non-operating humidity: 20%-95% (non-condensing)

Packaging Content 1 x E283-Z90-AAV1
2 x CPU heatsinks
1 x Mini-DP to D-Sub cable
Packaging Dimensions: 982 x 588 x 268 mm

Part Numbers Barebone package: 6NE283Z90DR000ACV1*
Optional parts:
- 2-Section Rail kit (385-480mm): 25HB2-3A0204-K0R
- 2-Section Rail kit (660-840mm): 25HB2-3A0203-K0R
- RMA packaging: 6NE283Z90SR-RMA-A100



Learn more at <https://www.GIGABYTE.com/enterprise>

* All specifications are subject to change without notice. Please visit our website for the latest information.
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